

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>	10749103			
<b>Filing Date:</b>	30-Dec-2003			
<b>Title of Invention:</b>	Method of forming a multi-layer semiconductor structure incorporating a processing handle member			
<b>First Named Inventor:</b>	Rafael Reif			
<b>Filer:</b>	Christopher S. Daly/Trish McHugh			
<b>Attorney Docket Number:</b>	MIT-136BUS			
Filed as Small Entity				
<b>Utility      Filing Fees</b>				
<b>Description</b>	<b>Fee Code</b>	<b>Quantity</b>	<b>Amount</b>	<b>Sub-Total in USD(\$)</b>
<b>Basic Filing:</b>				
<b>Pages:</b>				
<b>Claims:</b>				
<b>Miscellaneous-Filing:</b>				
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
<b>Post-Allowance-and-Post-Issuance:</b>				
<b>Extension-of-Time:</b>				
Extension - 3 months with \$0 paid	2253	1	510	510

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				510